

# NOT RECOMMENDED FOR NEW DESIGN CONTACT US

**PAM2303** 

#### 3A LOW NOISE STEP-DOWN DC-DC CONVERTER

## **Description**

The PAM2303 is a 3A step-down DC-DC converter. It operates in two different modes: PSM and PWM modes. At light load, it automatically enters into the PSM mode to improve efficiency. At heavy load, the constant frequency PWM control performs excellent stability and transient response. No external compensation components are required.

The PAM2303 supports a range of input voltages from 2.7V to 5.5V. The output voltage is adjustable from 0.6V to the input voltage. The PAM2303 employs internal power switch and synchronous rectifier to minimize external part count and realize high efficiency. During shutdown, the input is disconnected from the output and the shutdown current is less than  $1\mu A$ . Other key features include overtemperature and short circuit protection, and under-voltage lockout to prevent deep battery discharge.

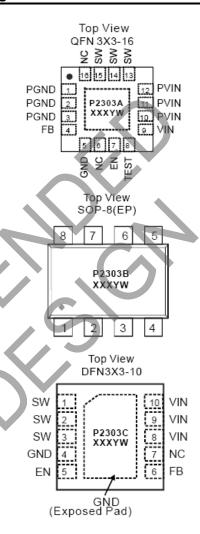
The PAM2303 delivers 3A maximum output current while consuming only  $42\mu A$  of no-load quiescent current. Ultra-Low  $R_{DS(ON)}$  integrated MOSFETs and 100% duty cycle operation make the PAM2303 an ideal choice for high-output voltage, high-current applications which require a low dropout threshold.

The PAM2303 is available in SOP-8(EP), DFN3X3-10 and QFN3X3-16 package.

#### **Features**

- Output Current: Up to 3A
- Output Voltage: 0.6V to V<sub>IN</sub>
- Input Voltage: 2.7 to 5.5V
- Efficiency up to 95%
- 42µA (typ) No Load Quiescent Current
- Shutdown Current: <1A</li>
- 100% Duty Cycle Operation
- 1.5MHz Switching Frequency
- Analog Soft Start
- No external Compensation Required
- Current Limit Protection
- Thermal Shutdown
- SOP-8(EP), DFN3X3-10 and QFN3X3-16 Package

## **Pin Assignments**

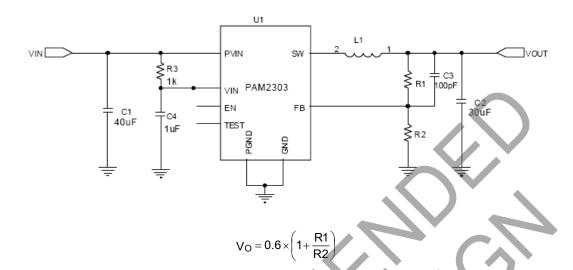


# **Applications**

- 5V or 3.3V Point of Load Conversion
- Telecom/Networking Equipment
- Set Top Boxes
- Storage Equipment
- Video Cards
- DDR Power Supply



# **Typical Applications Circuit**

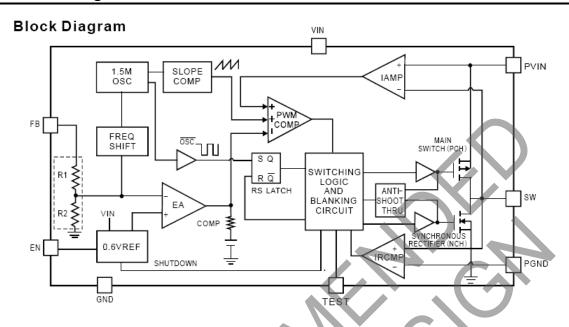


# **Pin Descriptions**

Pin	F	Package Nam	е	Function	
Name	QFN3x3-16	SOP-8EP	DFN3x3-10	Function	
PGND	1, 2, 3	2	_	Main power ground pin.	
FB	4	3	6	Feedback voltage to internal error amplifier, the threshold voltage is 0.6V.	
GND	5	4	4	Signal ground for small signal components.	
NC	6, 16	_	7	Not connected.	
EN	7	5	5	Enable control input. Force this pin voltage above 1.5V, enables the chip, and below 0.3V shuts down the device.	
Test	8	6		Test mode. "Low" connection is recommended.	
VIN	9	7	8, 9, 10	Bias supply. Chip main power supply pin.	
PVIN	10, 11, 12	8	<b>X</b> -/	Input supply for power stage. Must be closely decoupled to PGND.	
SW	13, 14, 15	1	1, 2, 3	The drains of the internalmain and synchronous power MOSFET.	



# **Functional Block Diagram**



# Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Input Voltage PV <sub>IN</sub> , V <sub>IN</sub>	6	V
SW Pin Voltage	-0.3 to (PV <sub>IN</sub> +0.3)	V
FB Pin Voltage	-0.3 to (V <sub>IN</sub> +0.3)	V
EN Pin Voltage	-0.3 to +6.0	V
Maximum Junction Temperature	+150	°C
Storage Temperature Range	-65 to +150	°C
Soldering Temperature	+300, 5s	°C

# Recommended Operating Conditions (@TA = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage	2.7 to 5.5	V
Junction Temperature Range	-40 to +125	Š
Ambient Temperature Range	-40 to +85	C

## **Thermal Information**

Parameter	Symbol	Package	Max	Unit
		SOP-8EP	90	°C/W
Thermal Resistance (Junction to Ambient)	θJA	DFN3x3-10	60	
		QFN3x3-16	35	
		SOP-8EP	11	
Thermal Resistance (Junction to Case)	$\theta_{ m JC}$	DFN3x3-10	8.5	
		QFN3x3-16	11	

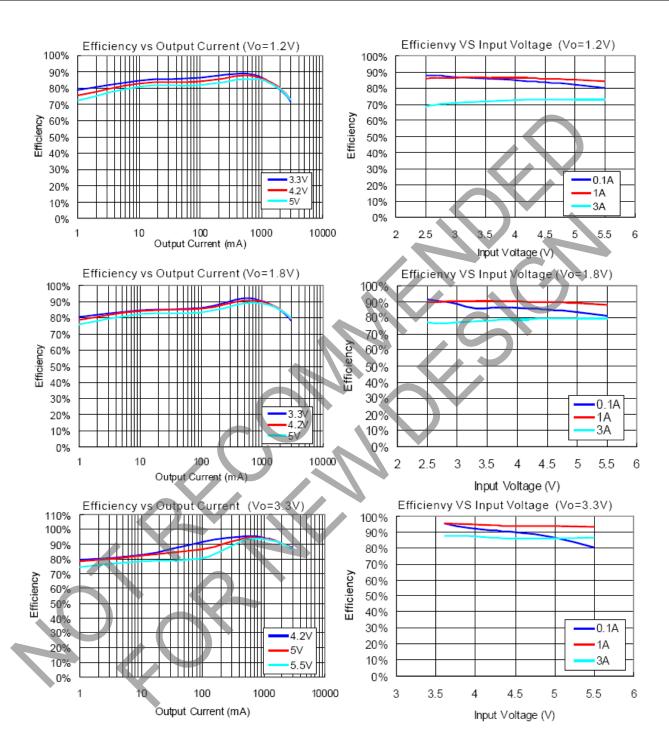


# $\textbf{Electrical Characteristics} \ (@T_A = +25^{\circ}C, \ V_{IN} = 3.6V, \ V_O = 1.8V, \ C_{IN} = 33\mu\text{F}, \ C_O = 22\mu\text{F}, \ L = 2.2\mu\text{H} \ unless otherwise specified.})$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Input Voltage Range	V <sub>IN</sub>	_	2.7	_	5.5	V
Output Voltage Range	Vo	_	0.6	_	V <sub>IN</sub>	V
	1	V <sub>IN</sub> Rising	_	2.4	2.5	V
UVLO Threshold	V <sub>UVLO</sub>	Hysteresis	1	240	1	mV
		V <sub>IN</sub> Falling	1.8		_	V
Regulated Output Voltage Accuracy	Vo	I <sub>O</sub> = 0 to 3A	-3	- \	+3	%
Regulated Feedback Voltage	$V_{FB}$	_	0.591	0.600	0.609	V
FB Leakage Current	I <sub>FB</sub>	V <sub>O</sub> = 1V	-50		+50	nA
Output Voltage Line Regulation	LNR	V <sub>IN</sub> = 2.5V to 5V	X	0.2		%/V
Output Voltage Load Regulation	LDR	I <sub>O</sub> = 0A to 3A	7	0.5	_	%/A
Quiescent Current	IQ	No load		42	90	μΑ
Shutdown Current	I <sub>SD</sub>	V <sub>EN</sub> = 0V	<b>V</b> _	1	1	μΑ
Current Limit	I <sub>LIM</sub>	_	<u> </u>	4		Α
Oscillator Frequency	fosc	-	1.2	1.5	1.8	MHz
Drain-Source On-State Resistance	Provenu	High Side	4-	85		mΩ
Dialii-Source Oii-State Resistance	R <sub>DS(ON)</sub>	Low Side	7	60	_	11177
High Efficiency	η	-	_	95	_	%
PSM Threshold	I <sub>TH</sub>	$V_{IN} = 3.3V, V_{O} = 1.2V, L = 1 \mu H$	<u> </u>		450	mA
Analog Soft Start Time	ts	From enable to output regulation		0.5	_	ms
EN Threshold High	V <sub>EH</sub>	-	1.5	_	_	V
EN Threshold Low	V <sub>EL</sub>		_	_	0.3	V
EN Leakage Current	I <sub>EN</sub>	$V_{IN} = V_{EN} = 0V$	-1.0	_	+1.0	μΑ
Over Temperature Protection	OTP		_	+150	_	°C
OTP Hysteresis	OTH	-		+30	_	°C

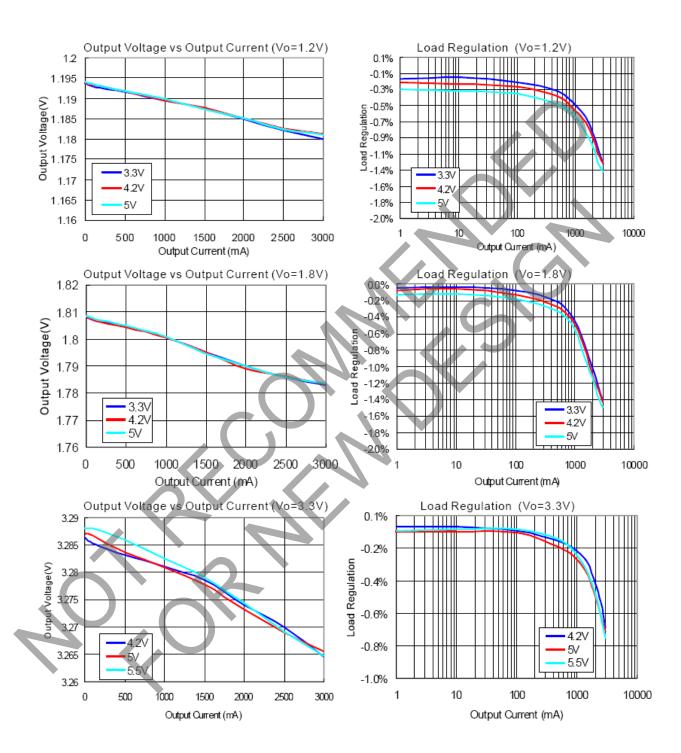


# $\textbf{Typical Performance Characteristics} \ (@T_A = +25^{\circ}C,\ C_{IN} = 10\mu\text{F},\ C_O = 10\mu\text{F},\ L = 4.7\mu\text{H unless otherwise specified.})$



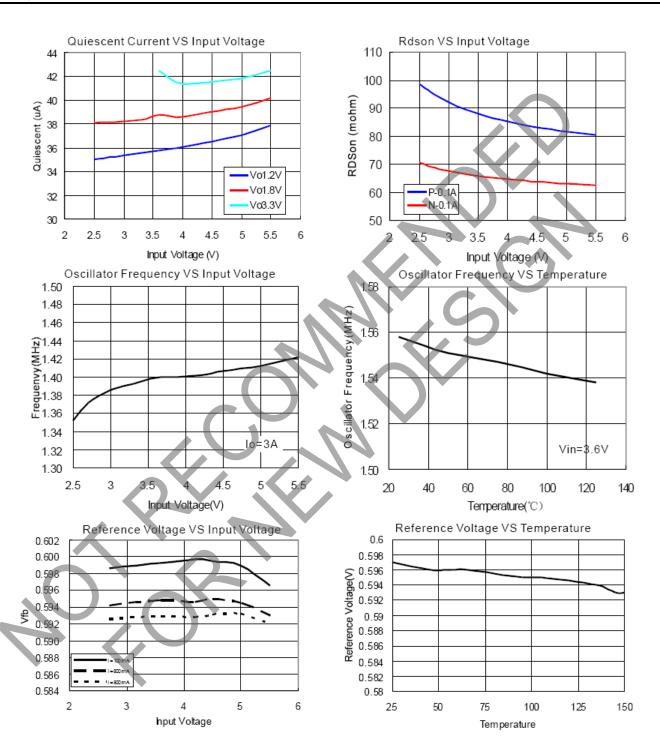


**Typical Performance Characteristics** (continued) (@ $T_A = +25^{\circ}C$ ,  $C_{IN} = 10\mu F$ ,  $C_O = 10\mu F$ ,  $L = 4.7\mu H$  unless otherwise specified.)





# **Typical Performance Characteristics** (continued) @ $T_A$ = +25°C, $C_{IN}$ = 10 $\mu$ F, $C_O$ = 10 $\mu$ F, L = 4.7 $\mu$ H unless otherwise specified.)





## Application Information

The basic PAM2303 application circuit is shown in Page 1. External component selection is determined by the load requirement, selecting L first and then CIN and COUT.

#### **Inductor Selection**

For most applications, the value of the inductor will fall in the range of 1µH to 3.3µH. Its value is chosen based on the desired ripple current and efficiency. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher VIN or VOUT also increases the ripple current as shown in equation 3A reasonable starting point for setting ripple current is  $\Delta I_L = 1.2A$  (40% of 3A).

$$\Delta I_{L} = \frac{1}{(f)(L)} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$
 Equation 1

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 4.2A rated inductor should be enough for most applications (3A + 1.2A). For better efficiency, choose a low DC-resistance inductor.

Vo	1.2V	1.5V	1.8V	2.5V	3.3V
L	1μH	1.5µH	2.2µH	2.2µH	3.3µH

#### CIN and COUT Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle V<sub>OUT</sub>/V<sub>IN</sub>. To prevent large voltage transients, allow ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN}$$
 required  $I_{RMS} \cong I_{OMAX} \frac{\left[V_{OUT}(V_{IN} - V_{OUT})\right]^{1/2}}{V_{IN}}$ 

This formula has a maximum at V<sub>IN</sub> = 2V<sub>OUT</sub>, where I<sub>RMS</sub> = I<sub>OUT</sub> /2. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Consult the manufacturer if there is any question.

The selection of C<sub>OUT</sub> is driven by the required effective series resistance (ESR).

Typically, once the ESR requirement for Cout has been met, the RMS current rating generally far exceeds the IRIPPLE (P-P) requirement. The output ripple  $\Delta V_{OUT}$  is determined by:

$$\Delta V_{OUT} \approx \Delta I_{L}(ESR = 1/8fC_{OUT})$$

Where f = operating frequency, C = output capacitance and  $\Delta I_L$  = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since  $\Delta I_L$  increases with input voltage.

#### **Using Ceramic Input and Output Capacitors**

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. Using ceramic capacitors can achieve very low output ripple and small circuit size.

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

#### Thermal Consideration

Thermal protection limits power dissipation in the PAM2303. When the junction temperature exceeds +150°C, the OTP (Over Temperature Protection) starts the thermal shutdown and turns the pass transistor off. The pass transistor resumes operation after the junction temperature drops below +120°C.

For continuous operation, the junction temperature should be maintained below +125°C.

The power dissipation is defined as:

$$P_D = I_O^2 \frac{V_O R_{DSONH} + (V_{IN} - V_O) R_{DSONL}}{V_{IN}} + (t_{SW} F_S I_O + I_Q) V_{IN}$$

IQ is the step-down converter quiescent current. The term tsw is used to estimate the full load step-down converter switching losses.

8 of 14 PAM2303 February 2020 www.diodes.com Document number: DS36385 Rev. 3 - 3 © Diodes Incorporated



## **Application Information** (continued)

#### **Thermal Consideration (continued)**

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

$$P_D = I_O^2 R_{DSON H} + I_Q V_{IN}$$

Since R<sub>DS(ON)</sub>, quiescent current, and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction and ambient. The maximum power dissipation can be calculated by the following formula:

$$P_D = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where TJ(max) is the maximum allowable junction temperature +125°C.  $T_A$  is the ambient temperature and  $\theta_{JA}$  is the thermal resistance from the junction to the ambient. Based on the standard JEDEC for a two layers thermal test board, the thermal resistance  $\theta_{JA}$  of QFN3X3-16 68°C/W and SOP-8(EP) 90°C/W, respectively. The maximum power dissipation at  $T_A$  = +25°C can be calculated by the following formula:

$$P = (125^{\circ}\text{C} - 25^{\circ}\text{C})/68^{\circ}\text{C/W} = 1.47\text{W}(\text{QFN3X3-16})$$
  
$$P = (125^{\circ}\text{C} - 25^{\circ}\text{C})/90^{\circ}\text{C/W} = 1.11\text{W}(\text{SOP-8})$$

#### **Setting the Output Voltage**

The internal reference is 0.6V (Typical). The output voltage is calculated as below The output voltage is given by Table 1.

$$V_0 = 0.6 \times \left(1 + \frac{R1}{R2}\right)$$

Table 1: Resistor recommended for output voltage setting

Vo	R1	R2
1.2V	150k	150k
1.5V	225k	150k
1.8V	300k	150k
2.5V	475k	150k
3.3V	680k	150k

### Pulse Skipping Mode (PSM) Description

When load current decreases, the peak switch current in Power-PMOS will be lower than skip current threshold and the device will enter into Pulse Skipping Mode.

In this mode, the device has two states, working state and idle state. First, the device enters into working state cont rolled by internal error amplifier. When the feedback voltage gets higher than internal reference voltage, the device will enter into low I idle state with most of internal blocks disabled. The output voltage will be reduced by loading or leakage current. When the feedback voltage gets lower than the internal reference voltage, the convertor will start a working state again.

## 100% Duty Cycle Operation

As the input voltage approaches the output voltage, the converter turns the P-Channel transistor continuously on. In this mode the output voltage is equal to the input voltage minus the voltage drop across the P-Channel transistor:

$$V_{OUT} = V_{IN} - I_{LOAD} (R_{DSON} + R_L)$$

where R<sub>DSON</sub> = P-Channel switch ON resistance, I<sub>LOAD</sub> = Output current, R<sub>L</sub> = Inductor DC resistance

#### **UVLO and Soft-Start**

The reference and the circuit remain reset until the  $V_{\text{IN}}$  crosses its UVLO threshold.

The PAM2303 has an internal soft-start circuit that limits the in-rush current during start-up. This prevents possible voltage drops of the input voltage and eliminates the output voltage overshoot. The soft-start make the output voltage rise up smoothly.



## **Application Information** (continued)

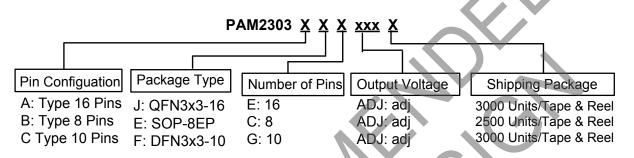
#### **Short Circuit Protection**

The switch peak current is limited cycle-by-cycle to a typical value of 4A. In the event of an output voltage short circuit, the device operates with a frequency of 500kHz and minimum duty cycle, therefore the average input current is more smaller than current limit.

#### **Thermal Shutdown**

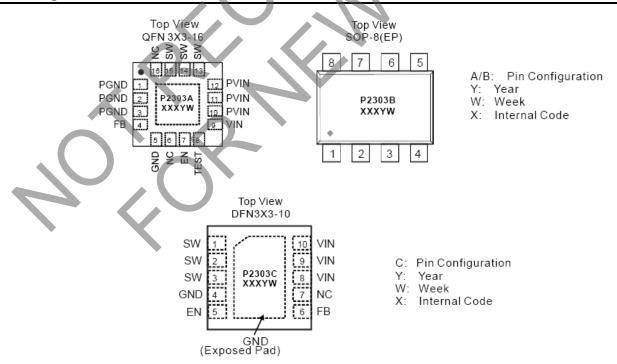
When the die temperature exceeds +150°C, a reset occurs and the reset remains until the temperature decrease to +120°C, at which time the circuit can be restarted.

## **Ordering Information**



Part Number	Output Voltage	Package	Packaging
PAM2303AJEADJR	ADJ	QFN3x3-16	3000 Units/Tape & Reel
PAM2303BECADJR	ADJ	SOP-8EP	2500 Units/Tape & Reel
PAM2303CFGADJR	ADJ	DFN3x3-10	3000 Units/Tape & Reel

# **Marking Information**

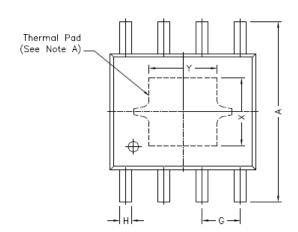




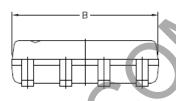
# Package Outline Dimensions (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOP-8EP



1	DIMEN	DIMENSIONS			
REF.	Millim	neters			
	Min.	Max.			
Α	5.80	6,20			
В	4.80	5,00			
С	3.80	4,00			
D	0.	8*			
Ε	0.40	0.90			
F	0,19	0.25			
M	0	0.15			
Н	0.35	0.49			
L	1.35	1.75			
G	1.27	TYP.			
Option1 X	2.2	28			
Y	2.2	28			
Ortion 2 X	2.	2.41			
Option2 Y	3.3	30			



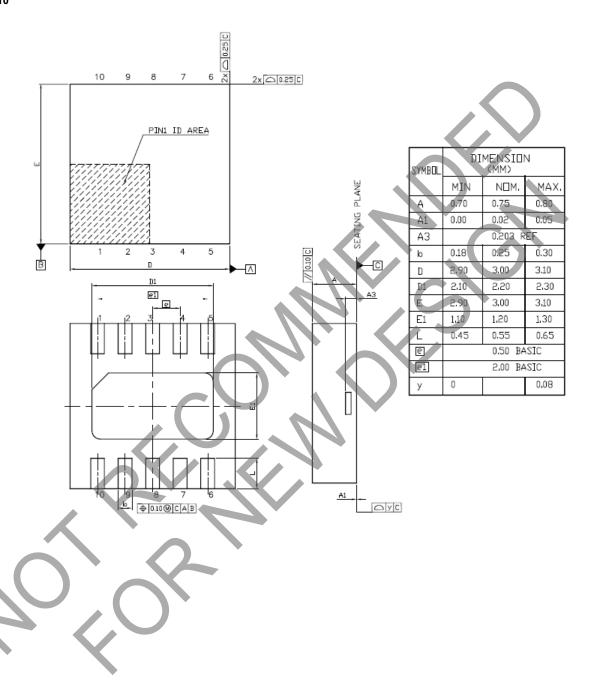




# Package Outline Dimensions (continued) (All dimensions in mm.)

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### DFN3x3-10

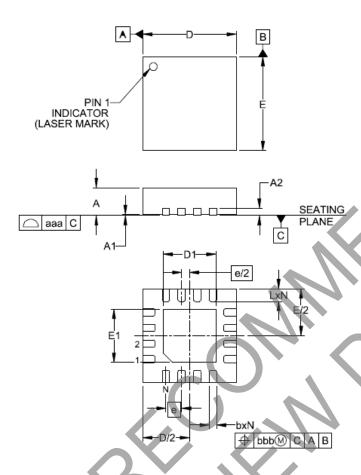




# Package Outline Dimensions (continued) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### QFN3x3-16



DIN	DIMENSIONS (Millieters)					
	MIN	TYP	MAX			
Α	0.50	0.55	0.60			
A1	0.00	0.02	0.05			
A2		0.20				
b	0.18	0.25	0.30			
D	2.90	3.00	3.10			
D1	1.55	1.70	1.80			
Ш	2.90	3.00	3.10			
E1	1.55	1.70	1.80			
æ		0.50BSC				
L	0.30	0.40	0.50			
N		16				
aaa		0.08				
bbb		0.10	·			

Notes:

- Controlling dimensions are millimeters (angles in degrees).
   Coplanarity applies to the exposed pads as well as the terminals.
- 3. DAP is 1.90 x 1.90mm.



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